

# FQP16N25C Datasheet

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DiGi Electronics Part Number	FQP16N25C-DG
Manufacturer	<a href="#">onsemi</a>
Manufacturer Product Number	FQP16N25C
Description	MOSFET N-CH 250V 15.6A TO220-3
Detailed Description	N-Channel 250 V 15.6A (Tc) 139W (Tc) Through Hole TO-220-3



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## Purchase and inquiry

Manufacturer Product Number:

FQP16N25C

Series:

QFET®

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

250 V

Drive Voltage (Max Rds On, Min Rds On):

10V

Vgs(th) (Max) @ Id:

4V @ 250µA

Vgs (Max):

±30V

FET Feature:

-

Operating Temperature:

-55°C ~ 150°C (Tj)

Supplier Device Package:

TO-220-3

Base Product Number:

FQP1

Manufacturer:

onsemi

Product Status:

Obsolete

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

15.6A (Tc)

Rds On (Max) @ Id, Vgs:

270mOhm @ 7.8A, 10V

Gate Charge (Qg) (Max) @ Vgs:

53.5 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

1080 pF @ 25 V

Power Dissipation (Max):

139W (Tc)

Mounting Type:

Through Hole

Package / Case:

TO-220-3

## Environmental & Export classification

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095



March 2013

# FQP16N25C / FQPF16N25C

## N-Channel QFET<sup>®</sup> MOSFET

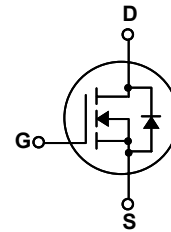
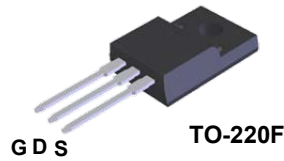
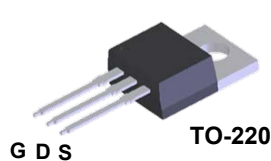
250 V, 15.6 A, 270 mΩ

### Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

### Features

- 15.6 A, 250 V,  $R_{DS(on)}=270\text{ m}\Omega(\text{Max.})@V_{GS}=10\text{ V}, I_D=7.8\text{ A}$
- Low Gate Charge (Typ. 41 nC)
- Low  $C_{rss}$  (Typ. 68 pF)
- 100% Avalanche Tested



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	FQP16N25C	FQPF16N25C	Unit
$V_{DSS}$	Drain-Source Voltage	250		V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ ) - Continuous ( $T_C = 100^\circ\text{C}$ )	15.6	15.6 *	A
		9.8	9.8 *	A
$I_{DM}$	Drain Current - Pulsed (Note 1)	62.4	62.4 *	A
$V_{GSS}$	Gate-Source Voltage	$\pm 30$		V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	410		mJ
$I_{AR}$	Avalanche Current (Note 1)	15.6		A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	13.9		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5.5		V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ ) - Derate above $25^\circ\text{C}$	139	43	W
		1.11	0.34	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150		$^\circ\text{C}$
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		$^\circ\text{C}$

\* Drain current limited by maximum junction temperature.

### Thermal Characteristics

Symbol	Parameter	FQP16N25C	FQPF16N25C	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.9	2.89	$^\circ\text{C}/\text{W}$
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$

**Electrical Characteristics** $T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
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**Off Characteristics**

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	250	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.31	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 250\text{ V}, V_{GS} = 0\text{ V}$	--	--	10	$\mu\text{A}$
		$V_{DS} = 200\text{ V}, T_C = 125^\circ\text{C}$	--	--	100	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -30\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA

**On Characteristics**

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2.0	--	4.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 7.8\text{ A}$	--	0.22	0.27	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 40\text{ V}, I_D = 7.8\text{ A}$ (Note 4)	--	10.5	--	S

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	830	1080	pF
$C_{oss}$	Output Capacitance		--	170	220	pF
$C_{rss}$	Reverse Transfer Capacitance		--	68	89	pF

**Switching Characteristics**

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 125\text{ V}, I_D = 15.6\text{ A},$ $R_G = 25\ \Omega$	--	15	40	ns
$t_r$	Turn-On Rise Time		--	130	270	ns
$t_{d(off)}$	Turn-Off Delay Time		--	135	280	ns
$t_f$	Turn-Off Fall Time		(Note 4, 5)	--	105	220
$Q_g$	Total Gate Charge	$V_{DS} = 200\text{ V}, I_D = 15.6\text{ A},$ $V_{GS} = 10\text{ V}$	--	41	53.5	nC
$Q_{gs}$	Gate-Source Charge		--	5.6	--	nC
$Q_{gd}$	Gate-Drain Charge		(Note 4, 5)	--	22.7	--

**Drain-Source Diode Characteristics and Maximum Ratings**

$I_S$	Maximum Continuous Drain-Source Diode Forward Current	--	--	15.6	A	
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current	--	--	62.4	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 15.6\text{ A}$	--	--	1.5	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_S = 15.6\text{ A},$	--	260	--	ns
$Q_{rr}$	Reverse Recovery Charge	$dI_F / dt = 100\text{ A}/\mu\text{s}$ (Note 4)	--	2.47	--	$\mu\text{C}$

**Notes:**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $L = 2.7\text{ mH}, I_{AS} = 15.6\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{SD} \leq 15.6\text{ A}, dI/dt \leq 300\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width  $\leq 300\ \mu\text{s}$ , Duty cycle  $\leq 2\%$
5. Essentially independent of operating temperature

### Typical Characteristics

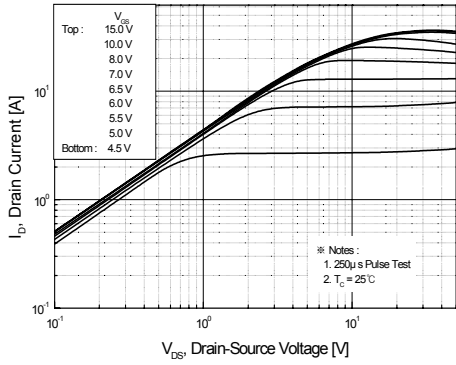


Figure 1. On-Region Characteristics

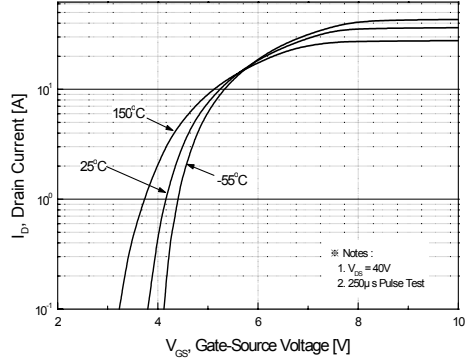


Figure 2. Transfer Characteristics

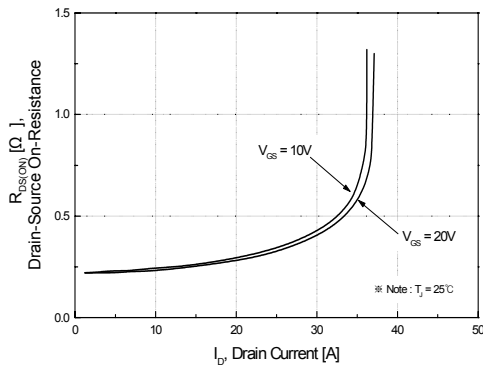


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

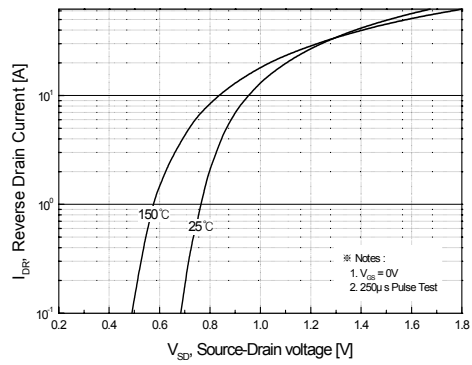


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

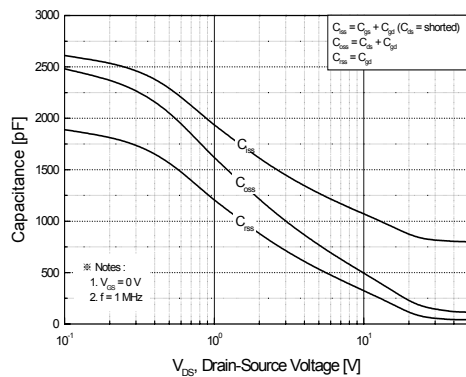


Figure 5. Capacitance Characteristics

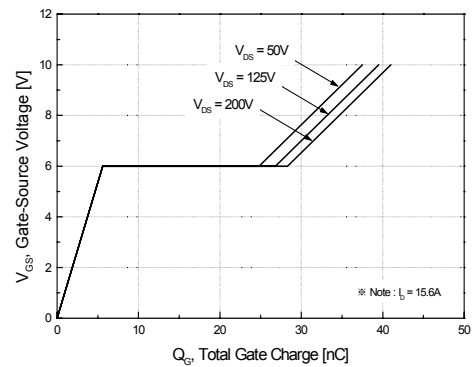
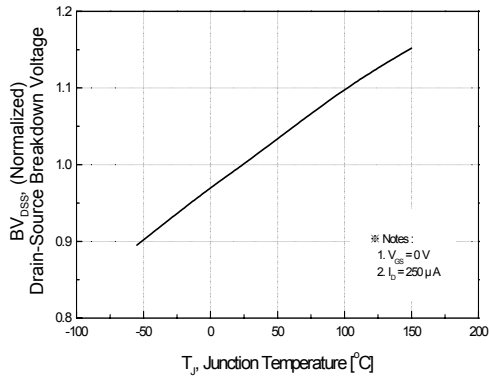
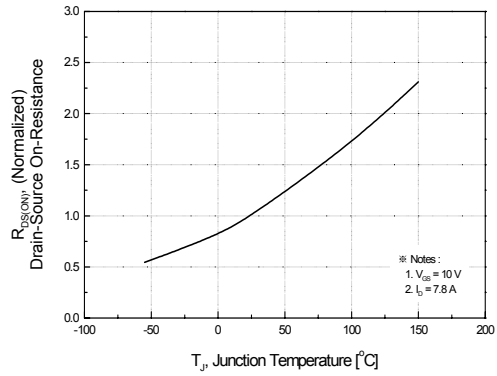


Figure 6. Gate Charge Characteristics

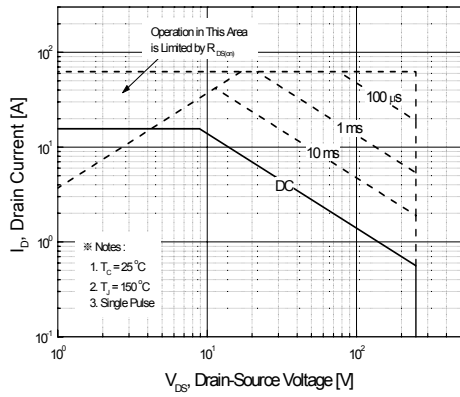
**Typical Characteristics** (Continued)



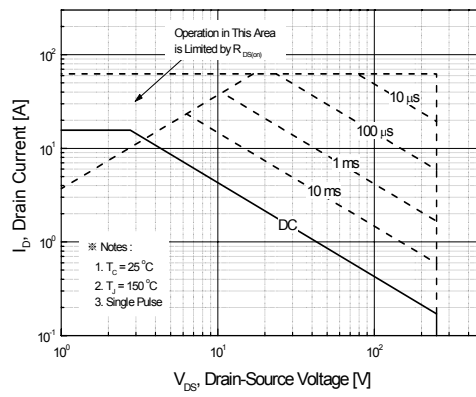
**Figure 7. Breakdown Voltage Variation vs Temperature**



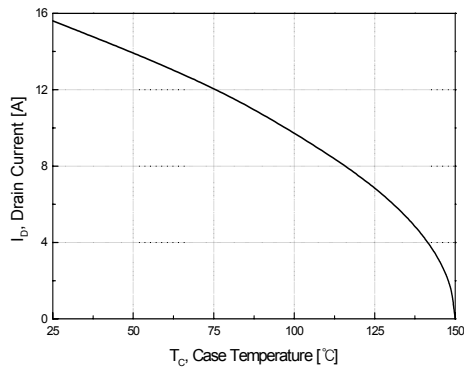
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9-1. Maximum Safe Operating Area for FQP16N25C**



**Figure 9-2. Maximum Safe Operating Area for FQPF16N25C**



**Figure 10. Maximum Drain Current vs Case Temperature**

Typical Characteristics (Continued)

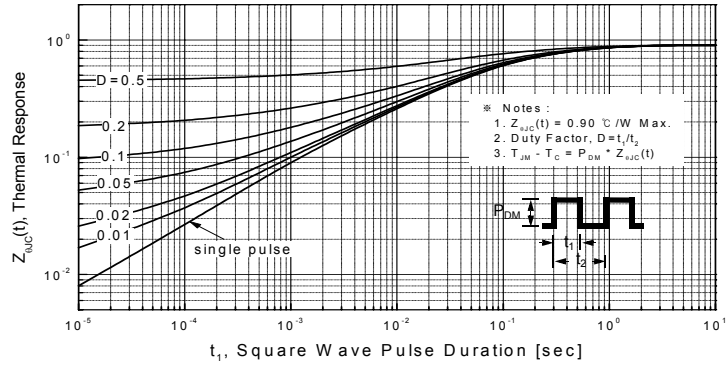


Figure 11-1. Transient Thermal Response Curve for FQP16N25C

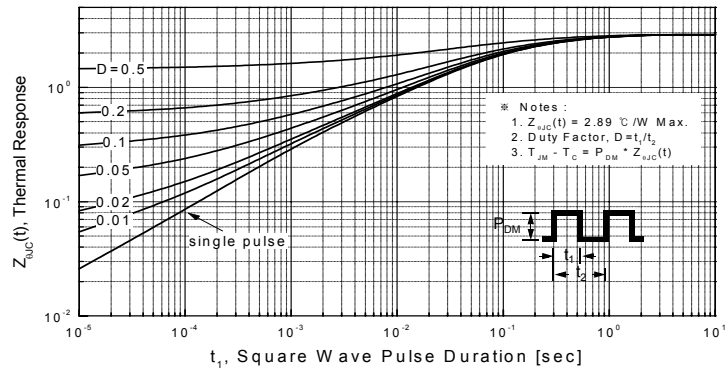
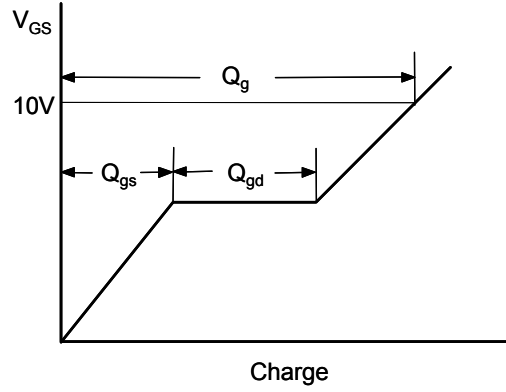
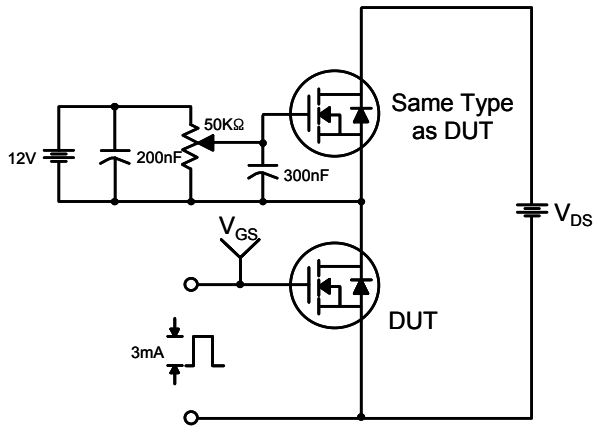
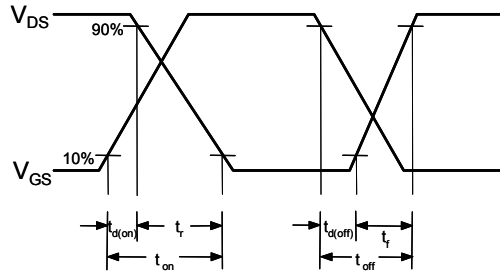
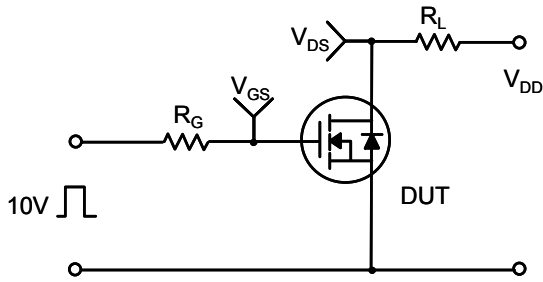


Figure 11-2. Transient Thermal Response Curve for FQPF16N25C

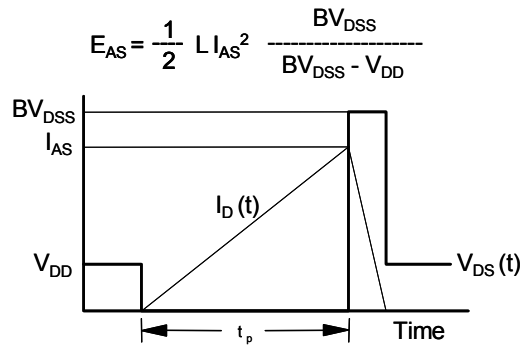
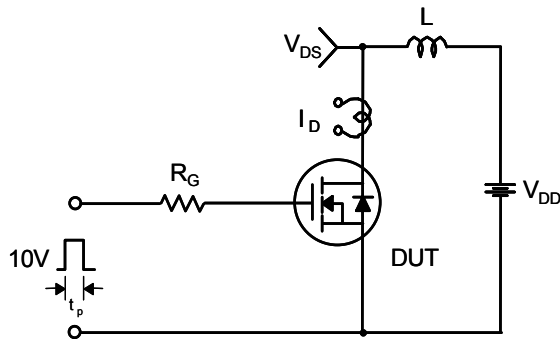
**Gate Charge Test Circuit & Waveform**



**Resistive Switching Test Circuit & Waveforms**

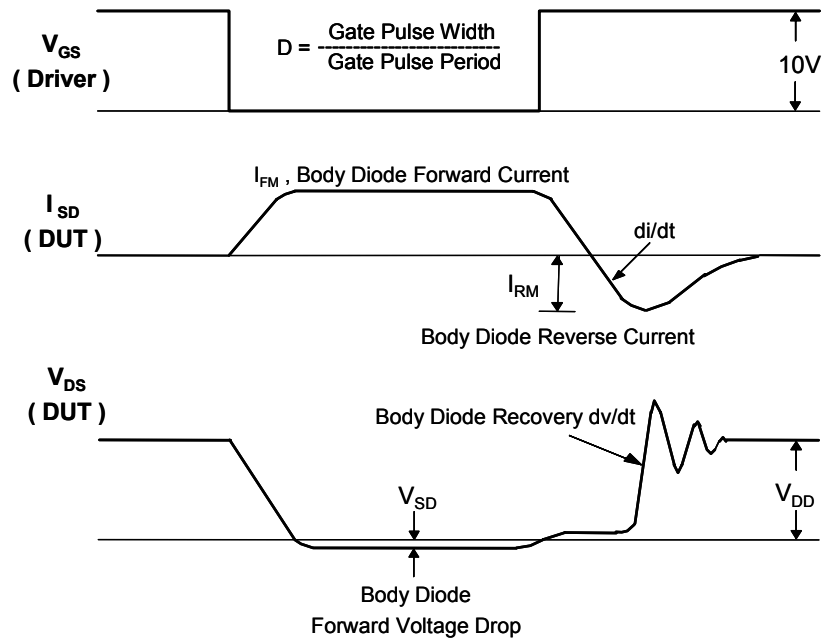
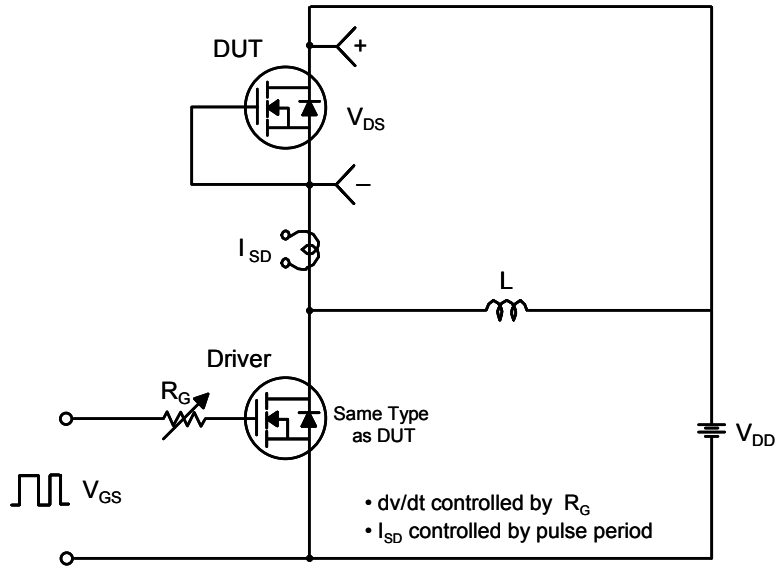


**Unclamped Inductive Switching Test Circuit & Waveforms**



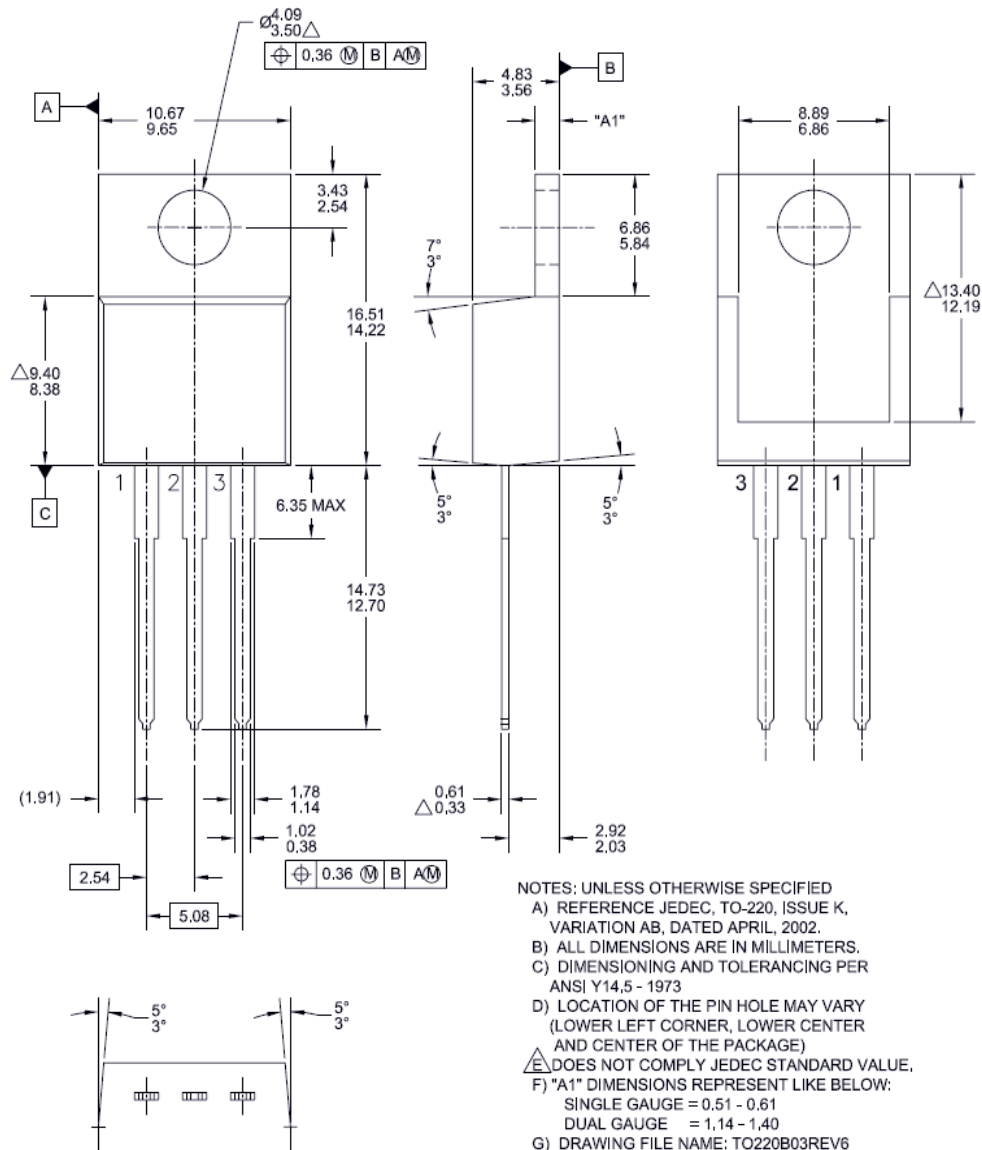


Peak Diode Recovery dv/dt Test Circuit & Waveforms



**Mechanical Dimensions**

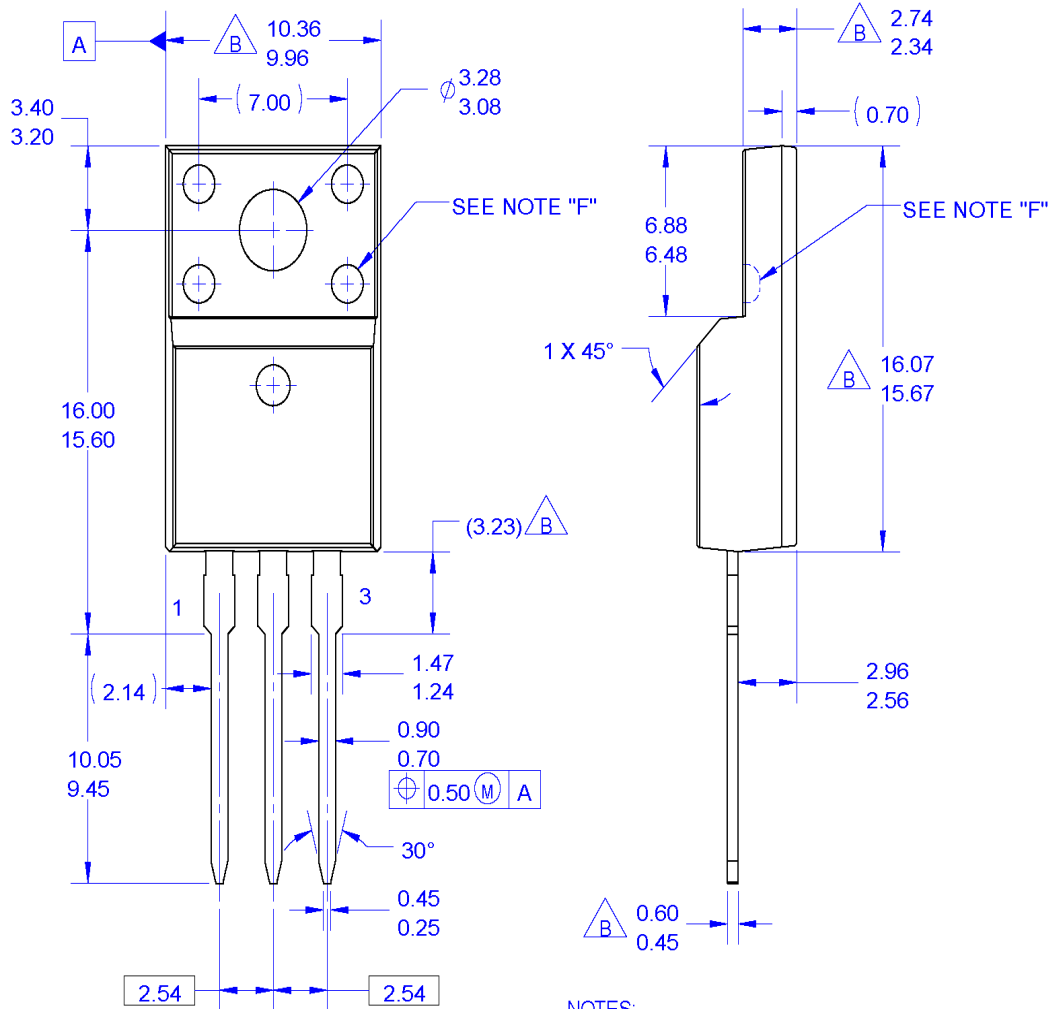
**TO-220**



Dimensions in Millimeters

**Mechanical Dimensions**

**TO-220F**



**NOTES:**

- A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A.
- B. DOES NOT COMPLY EIAJ STD. VALUE.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- F. OPTION 1 - WITH SUPPORT PIN HOLE.  
OPTION 2 - NO SUPPORT PIN HOLE.
- G. DRAWING FILE NAME: TO220M03REV3

Dimensions in Millimeters



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| BitSIC™                  | Global Power Resource <sup>SM</sup>             | TinyBuck™        |
| Build it Now™            | Green Bridge™                                   | TinyCalc™        |
| CorePLUS™                | Green FPS™                                      | TinyLogic®       |
| CorePOWER™               | Green FPS™ e-Series™                            | TINYOPTO™        |
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|                          | PowerXS™  |                  |
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|                          | QS™   |                  |
|                          | Quiet Series™                                   |                  |
|                          | RapidConfigure™                                 |                  |
|                          | ng our world, 1mW/W/kW at a time™               |                  |
|                          | SignalWise™                                     |                  |
|                          | SmartMax™                                       |                  |
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|                          | SPM®  |                  |
|                          | STEALTH™  |                  |
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|                          | SuperSOT™_3                                     |                  |
|                          | SuperSOT™_6                                     |                  |
|                          | SuperSOT™_8                                     |                  |
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**Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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